

Outgassing Compliant Power Inductors AE412PJB



- High temperature materials allow operation in ambient temperatures up to 155°C
- Passes NASA low outgassing specifications
- Special construction allows it to pass vibration testing to 80 G and shock testing to 1000 G.
- Tin-lead (Sn-Pb) termination for the best possible board adhesion

Core material Ferrite

Terminations Tin-lead (63/37) over tin over nickel.

Weight 50 – 62 mg

Ambient temperature –55°C to +105°C with (40°C) Irms current

Maximum part temperature +155°C (Ambient + temperature rise)

Storage temperature Component: –55°C to +155°C.

Tape and reel packaging: –55°C to +80°C

Resistance to soldering heat Max three 40 second reflows at +260°C, parts cooled to room temperature between cycles

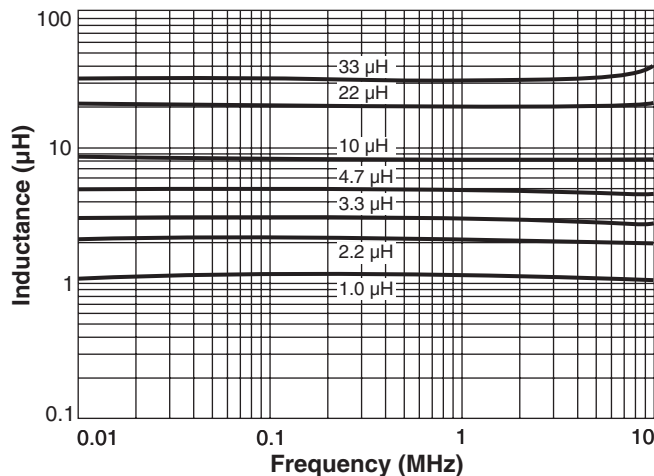
Moisture Sensitivity Level (MSL) 1 (unlimited floor life at <30°C / 85% relative humidity)

Enhanced crush-resistant packaging 1000/7" reel

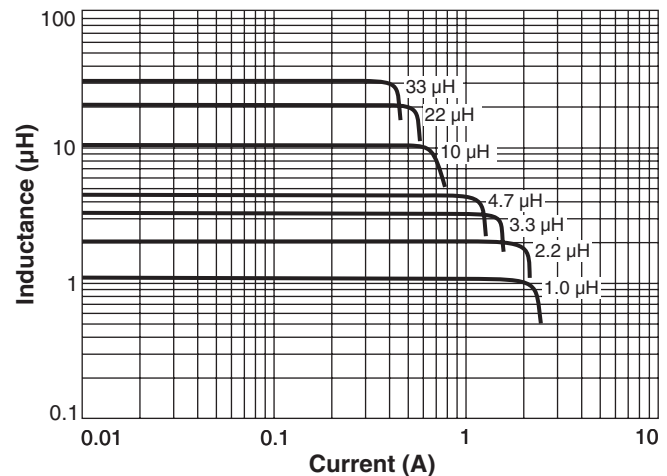
Plastic tape: 12 mm wide, 0.26 mm thick, 8 mm pocket spacing, 1.65 mm pocket depth

Recommended pick and place nozzle OD: 3 mm; ID: ≤1.5 mm

Typical L vs Frequency



Typical L vs Current



AE412PJB Series (3015)

Part number ¹	Inductance ² ±20% (µH)	DCR max ³ (Ohms)	SRF (MHz) ⁴		Isat (A) ⁵			Irms (A) ⁶	
			min	typ	10% drop	20% drop	30% drop	20°C rise	40°C rise
AE412PJB102MSZ	1.0	0.075	133	190	1.8	2.0	2.1	1.1	1.6
AE412PJB152MSZ	1.5	0.100	98.0	140	1.8	2.1	2.2	1.0	1.4
AE412PJB182MSZ	1.8	0.100	94.5	135	1.5	1.7	2.1	0.88	1.1
AE412PJB222MSZ	2.2	0.110	77.0	110	2.0	2.0	2.1	0.88	1.1
AE412PJB332MSZ	3.3	0.130	63.0	90	1.4	1.5	1.5	0.80	1.1
AE412PJB472MSZ	4.7	0.200	55.3	79	1.1	1.2	1.2	0.72	1.0
AE412PJB682MSZ	6.8	0.300	40.6	58	0.83	0.86	0.89	0.54	0.72
AE412PJB103MSZ	10	0.440	33.6	48	0.60	0.69	0.73	0.44	0.60
AE412PJB153MSZ	15	0.700	24.5	35	0.58	0.61	0.62	0.35	0.47
AE412PJB183MSZ	18	0.750	23.1	33	0.56	0.58	0.59	0.34	0.46
AE412PJB223MSZ	22	0.825	21.0	30	0.48	0.49	0.50	0.34	0.46
AE412PJB333MSZ	33	1.30	16.1	23	0.39	0.41	0.42	0.28	0.38
AE412PJB473MSZ	47	1.55	11.9	17	0.36	0.38	0.39	0.24	0.32
AE412PJB683MSZ	68	2.25	9.80	14	0.30	0.31	0.32	0.20	0.26
AE412PJB104MSZ	100	3.40	7.70	11	0.24	0.25	0.26	0.15	0.21
AE412PJB124MSZ	120	4.60	6.30	9.0	0.21	0.22	0.23	0.14	0.18
AE412PJB154MSZ	150	6.10	5.60	8.0	0.19	0.20	0.20	0.12	0.16
AE412PJB184MSZ	180	8.60	5.25	7.5	0.16	0.17	0.17	0.10	0.14
AE412PJB224MSZ	220	9.50	4.20	6.0	0.15	0.16	0.16	0.090	0.12
AE412PJB334MSZ	330	23.0	3.50	5.0	0.10	0.11	0.11	0.060	0.080

1. When ordering, please specify **screening** code:

AE412PJB334MSZ

Screening: Z = Unscreened

Y = Unscreened (SLDC Option A)

W = Unscreened (SLDC Option B)

H = Coilcraft CP-SA-10001 Group A

G = Coilcraft CP-SA-10001 Group A (SLDC Option A)

D = Coilcraft CP-SA-10001 Group A (SLDC Option B)

1 = EEE-INST-002 (Family 1) Level 1

2 = EEE-INST-002 (Family 1) Level 2

3 = EEE-INST-002 (Family 1) Level 3

4 = MIL-STD-981 (Family 04) Class B

5 = MIL-STD-981 (Family 04) Class S

F = ESCC3201 (F4 operational life performed at 105°C)

• Screening performed to the document's latest revision.

• Lot qualification (Group B) available.

• Testing T and U have been replaced with more detailed codes 4, 5, and 1, 2, 3, respectively. Codes T and U can still be used, if necessary. Custom testing also available.

• Country of origin restrictions available; prefix options G or F.

2. Inductance tested at 100 kHz, 0.1 Vrms using an Agilent/HP 4192A.

Inductance at 1 MHz is the same for parts with SRF ≥ 10 MHz.

3. DCR measured on a micro-ohmmeter.

4. SRF measured using an Agilent/HP 8753ES or equivalent.

5. DC current that causes the specified inductance drop from its value without current.

6. Current that causes the specified temperature rise from 25°C ambient. This information is for reference only and does not represent absolute maximum ratings.

7. Electrical specifications at 25°C.

Refer to Doc 362 "Soldering Surface Mount Components" before soldering.

